

Electronic Patent Application Fee Transmittal

Application Number:	10563463			
Filing Date:	05-Jan-2006			
Title of Invention:	Cucurbituril derivative-bonded solid substrate and biochip using the same			
First Named Inventor/Applicant Name:	Kimoon Kim			
Filer:	Joseph A. Hynds/Jessica Fu			
Attorney Docket Number:	1751-393			
Filed as Small Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Petition fee- 37 CFR 1.17(h) (Group III)	1464	1	130	130
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Statutory disclaimer	2814	1	70	70
Total in USD (\$)				200